Message from the Guest Editors

Dear Colleagues,

The 2nd International Conference on Mineral Engineering and Materials Science (iCMEMS2022, http://www.icmems.net.au) will be held in a hybrid format (in person and virtually) in Sydney, Australia, on 27–30 November 2022. The conference is to provide a platform for academics, researchers, graduates, and industry professionals to present and share their latest research and practice in the broad fields of mineral engineering, process metallurgy, material science and engineering, and particle science and technology.

We invite conference participants of iCMEMS2022 as well as other researchers to submit your high-quality manuscripts to this Special Issue of Materials: Advances in Materials, Chemical and Computational Science.

Deadline for manuscript submissions:
31 March 2023
Editor-in-Chief

Prof. Dr. Maryam Tabrizian
James McGill Professor, Professor of Biomedical Engineering, Professor of Bioengineering, Professor of Experimental Surgery, Department of Biomedical Engineering, Faculty of Medicine/Faculty of Dentistry, Duff Medical Science Building, 3775 University Street, Montreal, QC H3A 2B4, Canada

Message from the Editor-in-Chief

Materials (ISSN 1996-1944) was launched in 2008. The journal covers twenty comprehensive topics: biomaterials, energy materials, advanced composites, structure analysis and characterization, porous materials, manufacturing processes and systems, advanced nanomaterials, smart materials, thin films and interfaces, catalytic materials and carbon materials, materials chemistry, materials physics, optics and photonics, corrosion and materials degradation, construction and building materials, materials simulation and design, electronic materials, advanced and functional ceramics, metals and alloys, general. The distinguished and dedicated editorial board and our strict peer-review process ensure the highest degree of scientific rigor and review of all published articles. Materials provides a unique opportunity to contribute high quality articles and to take advantage of its large readership.

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Journal Rank: JCR - Q1 (Metallurgy & Metallurgical Engineering) / CiteScore - Q2 (Condensed Matter Physics)

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